## PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data		
1.1 Company	<b>577</b>	STMicroelectronics International N.V
1.2 PCI No.		AMS/20/12294
1.3 Title of PCI		Transfer of Final Testing (FT) from MUAR to TFME Subcontractor for the selected products (179803 prod line).
1.4 Product Category		See Products List
1.5 Issue date		2020-08-12

2. PCI Team	
2.1 Contact supplier	
2.1.1 Name	HARTMANN DORIS
2.1.2 Phone	+49 89460062186
2.1.3 Email	doris.hartmann@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Domenico ARRIGO
2.1.2 Marketing Manager	Mauro CONTI
2.1.3 Quality Manager	Alessandro PLATINI

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Testing (SOP 2617)	TFME (Subcon) as TnF plant

4. Description of change		
	Old	New
4.1 Description	MUAR as TnF plant	MUAR and TFME (Subcon) as TnF plant
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact	

5. Reason / motivation for change		
	The transfer of Final Test (FT) for the 1798 line to TFME (Subcontractors) is done to improve the rationalization of our production resources and to provide better support to our customers with greater volume production.	
5.2 Customer Benefit	CAPACITY INCREASE	

6. Marking of parts / traceability of change		
6.1 Description	Dedicated FGs	

7. Timing / schedule		
7.1 Date of qualification results	2020-09-30	
7.2 Intended start of delivery	2020-09-30	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation			
8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

	9. Attachments (additional documentations)
12294 Public product.pdf	

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	rt No 10.1.2 Supplier Part No 10.1.2 Supplier Part No	
TDE1798DP	TDE1798DP	

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